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PATENT
LDC-MASK

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

The Commissioner of Patents and Trademarks
Washington, D.C. 20231

Transmittal Letter

Submitted herewith for filing is a patent application of Paul D. Hammesfahr et al for REDUCING POLYMERIZATION STRESS BY CONTROLLED SEGMENTAL CURING, including an unexecuted Declaration.

The fee due is calculated as follows:

The filing fee is calculated as follows:

Basic Filing Fee		\$ 710.00
Total Claims	25 - 20 = 5 x 18 =	\$ 90.00
Independent Claims	13 - 3 = 10 x 80 =	\$ 800.00
Total filing fee		<u>\$1,160.00</u>

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Respectfully submitted,


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March 15, 2001
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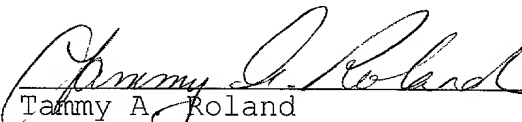


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